



Experiment Report Form

The double page inside this form is to be filled in by all users or groups of users who have had access to beam time for measurements at the ESRF.

Once completed, the report should be submitted electronically to the User Office using the **Electronic Report Submission Application**:

<http://193.49.43.2:8080/smis/servlet/UserUtils?start>

Reports supporting requests for additional beam time

Reports can now be submitted independently of new proposals – it is necessary simply to indicate the number of the report(s) supporting a new proposal on the proposal form.

The Review Committees reserve the right to reject new proposals from groups who have not reported on the use of beam time allocated previously.

Reports on experiments relating to long term projects

Proposers awarded beam time for a long term project are required to submit an interim report at the end of each year, irrespective of the number of shifts of beam time they have used.

Published papers

All users must give proper credit to ESRF staff members and proper mention to ESRF facilities which were essential for the results described in any ensuing publication. Further, they are obliged to send to the Joint ESRF/ ILL library the complete reference and the abstract of all papers appearing in print, and resulting from the use of the ESRF.

Should you wish to make more general comments on the experiment, please note them on the User Evaluation Form, and send both the Report and the Evaluation Form to the User Office.

Deadlines for submission of Experimental Reports

- 1st March for experiments carried out up until June of the previous year;
- 1st September for experiments carried out up until January of the same year.

Instructions for preparing your Report

- fill in a separate form for each project or series of measurements.
- type your report, in English.
- include the reference number of the proposal to which the report refers.
- make sure that the text, tables and figures fit into the space available.
- if your work is published or is in press, you may prefer to paste in the abstract, and add full reference details. If the abstract is in a language other than English, please include an English translation.



	Experiment title: Missing rotational symmetry vs. lateral and vertical ordering in InGaAs/GaAs(311)B quantum dot stacks	Experiment number: HS-2652
Beamline: ID10B	Date of experiment: from: 14.02.2007 to: 20.02.2007	Date of report: 29.01.2008
Shifts: 18	Local contact(s): Dr. Jiri Novak	<i>Received at ESRF:</i>
Names and affiliations of applicants (* indicates experimentalists): Dr. Michael Hanke* (Martin-Luther-University Halle-Wittenberg, Germany) Dr. Martin Schmidbauer* (Insitut for Crystal Growth, Berlin, Germany) Dr. Peter Schäfer* (Humboldt-University Berlin, Germany)		

Report:

We apologize for the short delay in submitting our report. This is partly due to the extensive data evaluation, and on the other hand due to sophisticated finite element calculations, which we had systematically to perform in order to receive a full picture of the strain and its relaxation in the probed InGaAs/GaAs quantum dot stacks. Eventually we have very recently published the results of this beamtime HS-3162 in the Applied Physics Letters: M. Hanke et al. APL **92**, 033111 (2008). So we have attached the corresponding paper as the essential part of our report.

Step bunch assisted two dimensional ordering of $\text{In}_{0.19}\text{Ga}_{0.81}\text{As}/\text{GaAs}$ quantum dots on vicinal $\text{GaAs}(001)$ surfaces

M. Hanke^{a)}

Martin-Luther-Universität Halle-Wittenberg, Institut für Physik, Hoher Weg 8, D-06120 Halle/Saale, Germany

Zh. M. Wang, Yu. I. Mazur, J. H. Lee, and G. J. Salamo

University of Arkansas, Department of Physics, Fayetteville, Arkansas 72701, USA

M. Schmidbauer

Institut für Kristallzüchtung, Max-Born-Straße 2, D-12489 Berlin, Germany

(Received 18 December 2007; accepted 8 January 2008; published online 25 January 2008)

We have investigated the self-organized, step bunch assisted formation of $\text{In}_{0.19}\text{Ga}_{0.81}\text{As}/\text{GaAs}$ quantum dots in vertical superlattices consisting of one, four, eight, and ten periods. Samples were grown by molecular beam epitaxy on vicinal 2°A and 2°B $\text{GaAs}(001)$ substrates. Those with miscut along the $[\bar{1}\bar{1}0]$ (2°B) exclusively show step bunches of an aspect ratio larger than 10 but without the formation of quantum dots. This highly linear pattern is improved during subsequent periods as proved by high resolution x-ray diffraction and grazing incidence diffraction. On the other hand, a miscut along the $[110]$ (2°A) initially causes a crosslike pattern of step bunches, which finally becomes a two-dimensional arrangement of individual quantum dots. © 2008 American Institute of Physics. [DOI: 10.1063/1.2838453]

Semiconductor quantum dots (QDs) and quantum wires (QWs) have attracted a long-lasting interest during the past decade because of potential applications in novel semiconductor devices.^{1–3} Since then a rather promising and so widely employed attempt relies on the so-called Stranski-Krastanow (SK) process. Here, the heteroepitaxy starts with a very thin, planar layer which wets the surface. With increasing thickness (respectively, ongoing growth), the established strain energy in the deformed crystal lattice increases too. Thus, at a certain point, the energy gain due to elastic relaxation overcompensates the additional free surface energy, and the self-organized growth mechanism changes from a planar layer-by-layer to a three-dimensional (3D) mode.

While the SK growth conditions can be optimized to produce nanostructures of nearly identical shape and size, often only a random spatial distribution of the QDs is observed for a single layer of QDs. However, the characteristics of many applications (e.g., the performance of photonic crystals) might be reinforced if the QD positions can be controlled to a high degree of precision. Self-assembling in a single QD layer can either be induced by pre patterning (lithographically^{4,5} or semiartificially by employing QWs as template for subsequent QD growth^{6,7}), or along a fully self-organized, strain-driven path, e.g., see Refs. 8–10. An additional degree of freedom is achieved if the QDs are vertically stacked in *multiple* layers, so they usually get more uniform in size and ordering. A range of different results, from nearly perfect QD chains¹¹ to 3D-QD lattices¹² has been reported. In the particular case of multilayered InGaAs QDs embedded in a GaAs matrix, both the anisotropic surface diffusion and the elastic properties of the GaAs spacer layer are the most important parameters for the evolution of 3D ordering of the QDs.¹³ Also, the effect of postgrowth annealing may play a

crucial role.¹⁴ However, in terms of custom-made 3D-QD lattices (with predictable lateral and vertical orderings) a more precise description of the QD growth and self-assembling has yet to be conceived.

The vertical superlattices investigated in this study were grown in a molecular beam epitaxy (MBE) chamber equipped with reflection high-energy electron diffraction. Double side polished, epitaxial ready *n*-type exact $\text{GaAs}(001)$ and vicinal $\text{GaAs}(001)$ substrates, tilted 2° toward the $[\bar{1}\bar{1}0]$ (2°B) and $[110]$ (2°A) directions, are loaded into the MBE chamber. As a reference point, an exact $\text{GaAs}(001)$ sample was loaded side-by-side next to each vicinal $\text{GaAs}(001)$ sample on a solid molybdenum block. The surface oxide layer was removed at 600°C for 10 min, while exposed to a $6.4\ \mu\text{Torr}$ As_4 beam equivalent pressure (BEP) from a solid source valved controlled As cell. After oxide desorption, substrate temperature was lowered to 580°C and a $0.4\ \mu\text{m}$ thick GaAs buffer layer was grown with a growth rate of $1.0\ \text{ML/s}$ and an As_4 to Ga BEP ratio of 10. Subsequently, the substrate was cooled down to 540°C , while keeping the As_4 BEP the same for the deposition of a $\text{InGaAs}/\text{GaAs}$ multilayer structure. The multilayer structure consists of *m* periods (with $m=1, 4, 8,$ and 10) of $20\ \text{ML}$ of $\text{In}_{0.19}\text{Ga}_{0.81}\text{As}$ on top of $20\ \text{ML}$ of a GaAs spacer with a $10\ \text{s}$ growth interruption between each layer. The Ga growth rate during the growth of the $\text{In}_{0.19}\text{Ga}_{0.81}\text{As}$ multilayer structure was $0.37\ \text{ML/s}$. The last layer of InGaAs was left uncapped for topographic atomic force microscopy (AFM) imaging under ambient conditions. The growth was then followed by $10\ \text{s}$ of annealing and the sample was then quickly quenched while lowering the As_4 pressure.

X-ray scattering techniques may probe entire vertical stacks with exceptional high statistics, which makes them excellent analytical tools to study 3D ordering therein. Due to comparatively small QD volumes, highly brilliant x-ray

^{a)}Electronic mail: hanke@physik.uni-halle.de.

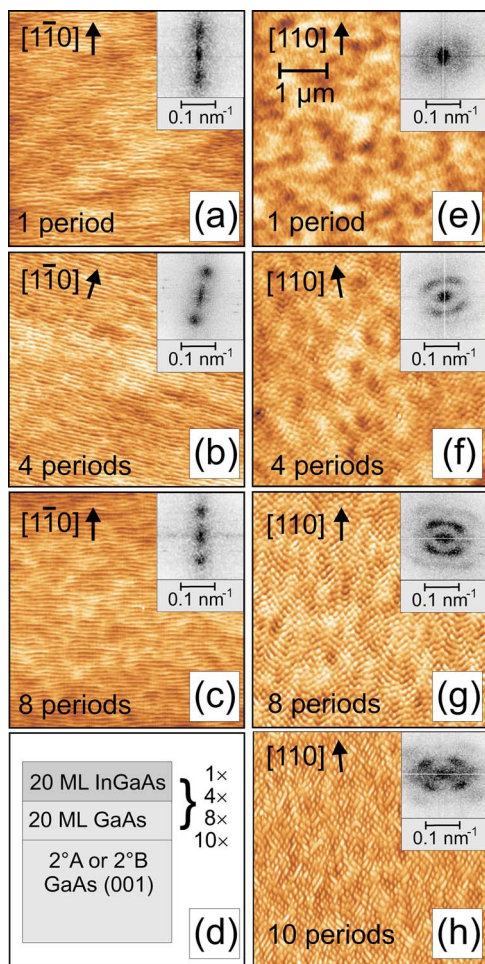


FIG. 1. (Color online) Atomic force micrographs ($5 \times 5 \mu\text{m}^2$) for two orthogonal substrate miscuts $\{2^\circ\text{B} [(a)–(c)]$ and $2^\circ\text{A} [(e)–(h)]\}$. The various superlattices contain either one [(a) and (e)], four [(b) and (f)], eight [(c) and (g)], or ten periods of 20 ML $\text{In}_{0.19}\text{Ga}_{0.81}\text{As}/20$ ML GaAs (h), see schematic sample setup (d). The insets depict corresponding fast Fourier transforms (FFTs). Please note that the scales therein directly accord with the x-ray scattering patterns in Figs. 2 and 3.

radiation becomes a mandatory requisit to measure the scattered x-ray intensity. We have first applied grazing incidence diffraction (GID) near the (220) reciprocal lattice point in order to probe the in-plane elastic strain and the lateral step bunch and QD ordering—both, in particular, near the surface, since the chosen angle of incidence of 0.5° figures only slightly above the critical angle for total external reflection. Respective measurements were performed at beamline ID10B at the European Synchrotron Radiation Facility (ESRF), Grenoble using an x-ray energy of 8 keV. A positional sensitive detector placed 500 mm behind the sample enables an angular resolution along different exit angles α_f . Furtheron, an additional Si(111) crystal analyzer had to be used in order to enhance the angular resolution parallel the sample surface to about 0.03 nm^{-1} .

For the same set of samples, we have applied high resolution x-ray diffraction (HRXRD) at beamline BW2 (HASYLAB) as a complementary technique to GID, using the identical x-ray energy of 8 keV. Since the information depth in HRXRD gets an order of magnitude higher, this probes now lateral ordering throughout the entire stack. A two-dimensional charge coupled device, which simultaneously records the intensity along a curved area in recipro-

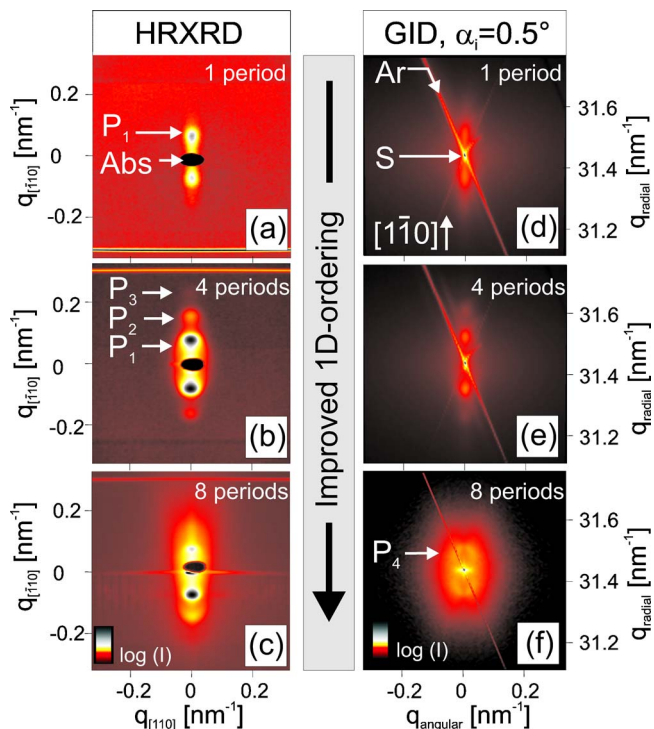


FIG. 2. (Color online) Diffusely scattered intensity near the (004) reflection [(a)–(c)] at $q_{\text{vertical}} = 44.0 \text{ nm}^{-1}$. An absorber (Abs) weakens highly intense scattering in the center of the image. (d)–(f) show the vicinity of the (220) GID reflection (S). The intensity distributions were measured at a single layer of InGaAs QDs (a) and (d) and various multilayer stacks containing four [(b) and (e)] and eight periods [(c) and (f)] on 2°B miscut GaAs(001), respectively. Several scattering satellites P_1 to P_4 probe the lateral ordering, (Ar) denotes a scattering artefact.

cal space, was utilized for recording 3D resolved scattering patterns. However, since we require *in-plane* intensity distributions (in order to compare them with respective GID measurements) respective sections through the 3D distribution have been extracted.

The atomic force micrographs in Fig. 1 clearly prove a different lateral ordering scenario for the 2°B [Figs. 1(a)–1(c)] and 2°A [Figs. 1(e)–1(h)] samples. The highly anisotropic (2×4) surface reconstruction on GaAs(001) induces anisotropic surface diffusion of the adatoms, which obviously favors step bunching in the first case [Figs. 1(a)–1(c)] and a two-dimensional alignment of QDs in the other [Figs. 1(e)–1(h)]. While the average inter-step-bunch (respectively, inter-QD) distance does not significantly change if the number of vertical layers increases (see insets in Fig. 1), the topmost surface morphology becomes a more pure one-dimensional (1D) [or two-dimensional (2D)], in case of 2°A miscut substrates] pattern, which is proved by corresponding fast Fourier transforms (FFTs). Corresponding FFTs are shown as insets in Fig. 1. It is worth noticing that the number and height of the bunched steps do not vary with the number of periods. While AFM exclusively probes the topmost surface HRXRD and GID, Fig. 2 (2°B) and Fig. 3 (2°A miscut samples), probe via different information depths the evolution of lateral ordering through the vertical stacks.

Both techniques yield a single ordering satellite P_1 in Figs. 2(a) and 2(d) for the 2°B single layer sample, similar to the FFT in Fig. 1(a). However, in contrast to that the scattering at both 2°B , vertical stacks with four and eight periods in Figs. 2(b), 2(c), 2(e), 2(f) exhibit a subsequently evolving 1D

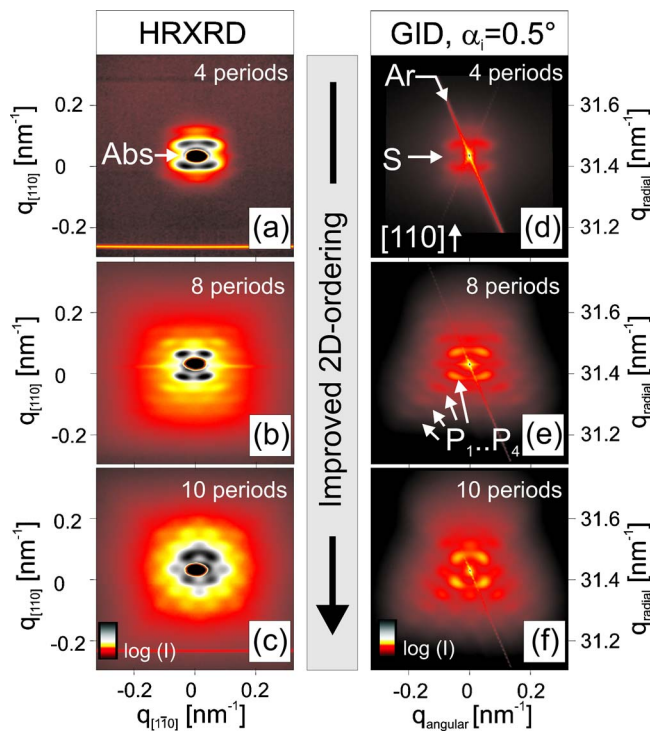


FIG. 3. (Color online) Diffusely scattered intensity near the (004) reflection [(a)–(c)] at $q_{\text{vertical}}=44.0 \text{ nm}^{-1}$. An absorber (abs) weakens highly intense scattering in the centre of the image. (d)–(f) show the vicinity of the (220) GID reflection (S). The intensity distributions were measured at InGaAs/GaAs QDs multilayer stacks containing four layers [(a) and (d)], eight layers [(b) and (e)], and ten periods [(c) and (f)] on 2°A miscut GaAs(001), respectively. Several scattering satellites P_1 – P_4 probe the lateral ordering. (Ar) denotes a scattering artefact.

ordering by the appearance of additional lateral ordering satellites $P_1 \dots P_3$ along the $[\bar{1}10]$ direction. The in-plane GID pattern in Fig. 2(f), and, in particular, the presence of peak P_4 , may be related to the 2D morphology at the tails of each bunch.

A similar trend of subsequently evolving lateral (however, 2D) ordering with increasing number of layers in a vertical stack was found for the samples on 2°A miscut substrates, Fig. 3. While the sample with just 4 periods shows a comparatively weak 2D pattern with lateral ordering satellites up to the first order around the substrate (S) peak [Figs. 3(a) and 3(d)], the in-plane patterns depict additional satel-

lites up to fourth order ($P_1 \dots P_4$) in case of 8 and 10 periods [Figs. 3(b), 3(c), 3(e), and 3(f)].

In conclusion, we have probed single and multilayer stacks of InGaAs/GaAs on 2°A and 2°B miscut GaAs(001) with direct atomic force microscopy, high resolution x-ray diffraction, and grazing incidence diffraction. We could show, that due to the vertical stacking, the lateral ordering on both orientations improves with increasing number of periods. While the surface on 2°B tends to form highly unidirectional 1D step bunches, the 2°A orientation yields highly ordered 2D QD patterns.

Financial support by the Federal State of Sachsen-Anhalt, Germany, within the Cluster of Excellence (CoE) *Nanostructured Materials*, project NW3 (M.H.) is highly appreciated. The authors thank the European Synchrotron Radiation Facility (ESRF), project HS-3162, and Hamburger Synchrotron Laboratory HASYLAB, for providing beamtime. The authors thank P. Schäfer (Humboldt-University, Berlin) and O. Konovalov (ESRF) for their assistance during the experiments.

¹V. A. Shchukin, N. N. Ledentsov, and D. Bimberg, *Epitaxy of Nanostructures* (Springer, New York, 2004).

²M. S. Skolnik and D. J. Mowbray, *Annu. Rev. Mater. Res.* **34**, 181 (2004).

³J. Stangl, V. Holý, and G. Bauer, *Rev. Mod. Phys.* **76**, 725 (2004).

⁴J. Liang, H. Luo, R. Beresford, and J. Xu, *Appl. Phys. Lett.* **85**, 5974 (2004).

⁵Z. M. Wang, J. H. Lee, B. L. Liang, W. T. Black, V. P. Kunets, Y. I. Mazur, and G. J. Salamo, *Appl. Phys. Lett.* **88**, 233102 (2006).

⁶M. Hanke, T. Boeck, A.-K. Gerlitzke, F. Syrowatka, F. Heyroth, and R. Köhler, *Appl. Phys. Lett.* **86**, 223109 (2005).

⁷V. Yazdanpanah, Z. M. Wang, J. H. Lee, and G. J. Salamo, *New J. Phys.* **8**, 233 (2006).

⁸Q. Xie, A. Madhukar, P. Chen, and N. Kobayashi, *Phys. Rev. Lett.* **75**, 2542 (1995).

⁹M. Meixner, E. Schöll, M. Schmidbauer, H. Raidt, and R. Köhler, *Phys. Rev. B* **64**, 245307 (2001).

¹⁰I. Berbezier, A. Ronda, A. Portavoce, and N. Motta, *Appl. Phys. Lett.* **83**, 4833 (2003).

¹¹T. Mano, R. Nötzel, G. J. Hamhuis, T. J. Eijkemans, and J. H. Wolter, *Appl. Phys. Lett.* **81**, 1705 (2002).

¹²G. Springholz, V. Holý, M. Pinczolits, and G. Bauer, *Science* **282**, 734 (1998).

¹³M. Schmidbauer, S. Seydmohamadi, D. Grigoriev, Z. M. Wang, Y. I. Mazur, P. Schäfer, M. Hanke, R. Köhler, and G. J. Salamo, *Phys. Rev. Lett.* **96**, 066108 (2006).

¹⁴T. Mano, R. Nötzel, G. J. Hamhuis, T. J. Eijkemans, and J. H. Wolter, *J. Appl. Phys.* **92**, 4043 (2002).